# TVS Diodes

**Transient Voltage Suppression Diodes** 



# **SACB Series**



## Description

SACB series is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

## **Applications**

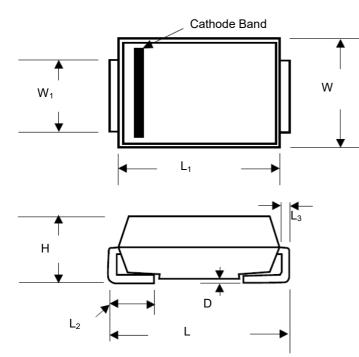
- Communication Equipment
- Security & Protection
- Industrial Control Equipment
- Power Supply
- Automotive Electronics
- New Energy
- Lightning Protection

#### Features

- 500 W peak pulse capability at 10/1000 μS waveform, repetition rate (duty cycles):0.01%
- For surface mounted applications in order to optimize board space
- Low profile package
- Built-in strain relief
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- IEC-61000-4-2 ESD 30 kV (Air), 30 kV (Contact)
- ESD protection of data lines in accordance with IEC 61000 -4-2
- EFT protection of data lines in accordance with IEC 61000-4-4
- V<sub>BR</sub> @ T<sub>J</sub>= V<sub>BR</sub>@25 °C x (1+αT x (T<sub>J</sub>-25))
- (αT:Temperature Coefficient, typical value is 0.1%)
- Glass passivated chip junction
- Fast response time: typically less than 1.0 PS from 0 V to BV min
- Excellent clamping capability
- Low incremental surge resistance
- High temperature reflow soldering guaranteed: 260 °C / 40 sec
- Plastic package is flammability rated V-0 per Underwriters Laboratories
- Meet MSL level1, per J-STD-020
- Matte tin lead-free plated
- Halogen free and RoHS compliant
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)



# Package Outline Dimensions (DO-214AA)



	Millime	eters	Inches		
Symbol	Min.	Max.	Min.	Max.	
W <sub>1</sub>	1.950	2.200	0.077	0.086	
L <sub>1</sub>	4.060	4.570	0.160	0.180	
W	3.300	3.940	0.130	0.155	
Н	2.130	2.440	0.084	0.096	
L <sub>2</sub>	0.760	1.520	0.030	0.060	
D	D -		-	0.008	
L	5.210	5.590	0.205	0.220	
L <sub>3</sub>	0.152	0.305	0.006	0.012	

DO-214AA (SMB J-Bend)

## **Maximum Ratings and Characteristics**

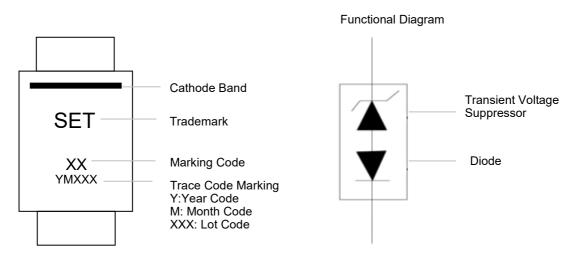
(T<sub>A</sub> = 25 °C unless otherwise specified.)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation at TL=25 °C by 10/1000 $\mu$ S Waveform (fig.1)( Note 1)	P <sub>PPM</sub>	500	W
Power Dissipation on Infinite Heat Sink at T∟=50 °C	P <sub>D</sub>	3.0	W
Operating Temperature Range	TJ	-65 to 150	°C
Storage Temperature Range	T <sub>STG</sub>	-65 to 175	°C

# Part Numbering System



# Marking





# Glossary

TVS

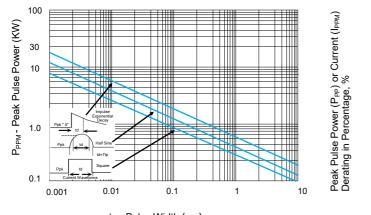
Item	Description					
Vc	<b>Clamping Voltage</b> Voltage across TVS in a region of low differential resistance that serves to limit the voltage across the device terminals.					
V <sub>R</sub>	<b>Reverse Stand-off Voltage</b> Maximum voltage that can be applied to the TVS without operation. NOTE : It is also shown as $V_{WM}$ (maximum working voltage (maximum d.c. voltage)) and known as rated stand-off voltage ( $V_{so}$ ).					
I <sub>R</sub>	Reverse Leakage CurrentCurrent measured at $V_{R.}$ NOTE : Also shown as $I_D$ for stand-by current.					
V <sub>BR</sub>	Breakdown Voltage Voltage across TVS at a specified current $I_{T}$ in the breakdown region.					
I <sub>PPM</sub>	Rated Random Recurring Peak Impulse Current   Maximum-rated value of random recurring peak impulse current that may be applied to a device.   Pated Average Rever Discipation					
P <sub>M(AV)</sub>	Rated Average Power Dissipation Maximum-rated value of power dissipation resulting from all sources, including transients and standby current, averaged over a short period of time.					
<b>Р</b> <sub>РРМ</sub>	Rated Random Recurring Peak Impulse Power Dissipation Maximum-rated value of the product of rated random recurring peak impulse current ( $I_{PPM}$ ) multiplies by specified maximum clamping voltage ( $V_{C}$ ).					
CJ	Capacitance Capacitance across the TVS measured at a specified frequency and voltage.					
V <sub>FS</sub>	Peak Forward Surge VoltagePeak voltage across an TVS for a specified forward surge current (IFS) and time duration.NOTE : Also shown as VF.					
I <sub>FS</sub>	Forward Surge Current   Pulsed current through TVS in the forward conducting region.   NOTE : Also shown as I <sub>F.</sub>					
α <sub>V(BR)</sub>	Temperature Coefficient of Breakdown VoltageThe change of breakdown voltage divided by the change of temperature.					
<b>I</b> PP	Peak pulse CurrentPeak pulse current value applied across the TVS to determine the clamping voltage $V_C$ for a specified wave shape.					
Ι <sub>Τ</sub>	<b>Pulsed D.C. Test Current</b> Test current for measurement of the breakdown voltage $V_{BR}$ . This is defined by the manufacturer and usually given in milliamperes with a pulse duration of less than 40 ms. NOTE : Also shown as $I_{BR}$ .					

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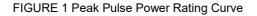
# Electrical Characteristics (T<sub>A</sub>=25 °C unless otherwise noted )Table 1

Part Number	Device Marking Code	Min. Breakdown Voltage at I <sub>r</sub> =1 mA V <sub>BR</sub>	Reverse Stand-off Voltage V <sub>R</sub>	Max. Reverse Leakage I <sub>R</sub> @V <sub>R</sub>	Max. Peak Pulse Current I <sub>PPM</sub>	Max. Clamping Voltage at V₀@Iբ <sub>PM</sub> =5.0A	Max. Junction Capacitance @0 Volts	Working Inverse Blocking Voltage Vwiß	Inverse Blocking Leakage Current at Iıß @ Vwiß	Peak Inverse Blocking Voltage VPIB
Uni	Uni	(V)	(V)	(μΑ)	(A)	(V	(pF)	(V)	(mA)	(V)
SACB5.0	SKE	7.60	5.0	300	44.0	10.0	45	75	1.0	100
SACB6.0	SKG	7.90	6.0	300	41.0	11.2	45	75	1.0	100
SACB7.0	SKM	8.33	7.0	300	38.0	12.6	45	75	1.0	100
SACB8.0	SKR	8.89	8.0	100	36.0	13.4	45	75	1.0	100
SACB8.5	SKT	9.44	8.5	50	34.0	14.0	45	75	1.0	100
SACB10	SKX	11.10	10.0	5	29.0	16.3	45	75	1.0	100
SACB12	SLE	13.30	12.0	5	25.0	19.0	45	75	1.0	100
SACB15	SLM	16.70	15.0	5	20.0	23.6	45	75	1.0	100
SACB18	SLT	20.00	18.0	5	15.0	28.8	45	75	1.0	100
SACB22	SLX	24.40	22.0	5	14.0	35.4	45	75	1.0	100
SACB26	SME	28.90	26.0	5	11.1	42.3	45	75	1.0	100
SACB30	SMK	33.30	30.0	5	10.0	48.6	45	75	1.0	100
SACB36	SMP	40.00	36.0	5	8.6	60.0	45	75	1.0	100
SACB45	SMV	50.00	45.0	5	6.8	77.0	45	150	1.0	200
SACB50	SMZ	55.50	50.0	5	5.8	88.0	45	150	1.0	200

## Performance Curve for Reference(T<sub>A</sub>=25 °C unless otherwise noted)



 $t_d$  – Pulse Width (ms)



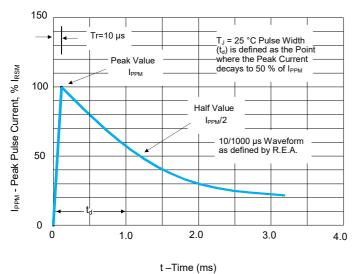
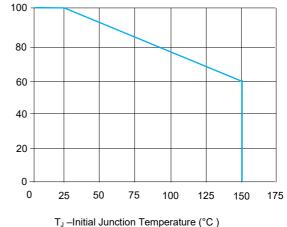


FIGURE 3 Pulse Waveform

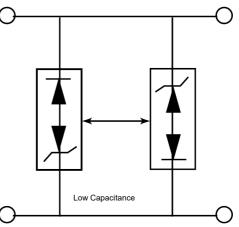


SETsafe | SET fuse

**SACB Series** 

TVS

FIGURE 2 Peak Pulse Power Derating Curve



**Application Note:** Device must be used with two units in parallel, opposite in polarity as shown on circuit for AC signal line protection.

FIGURE 4 AC Line Protection Application

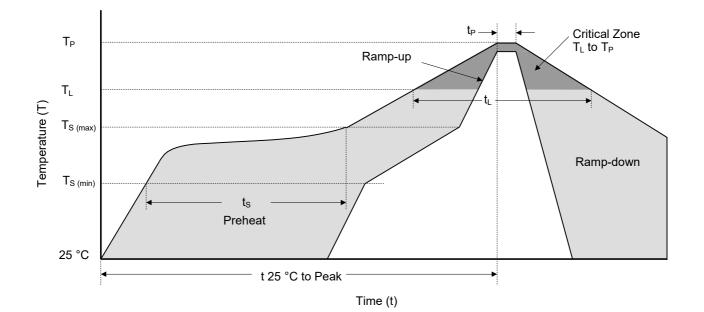
## **Environmental Specifications**

High Temp. Storage	JESD22-A103	
HTRB	JESD22-A108	
Temperature Cycling	JESD22-A104	
MSL	JEDEC-J-STD-020, Level 1	
H3TRB	JESD22-A101	
RSH	JESD22-A111	

# **Physical Specifications**

Weight	ght 0.003 oz., 0.093 g			
Case	JEDEC DO-214AA molded plastic body over glass passivated junction.			
Polarity	Color band denotes cathode except Bidirectional			
Terminal	Matte Tin-plated leads. Solderable per JESD22-B102.			

## **Soldering Parameters**



**Reflowing Condition** 

Reflow Solderin	Lead-Free Assembly			
	Temperature Min (T <sub>S (min)</sub> )	150 °C		
Pre-heat	Temperature Max (T <sub>S (max)</sub> )	200 °C		
	Time (min to max) ( $t_s$ )	60 ~ 120 seconds		
Average Ramp Up Rate (Li	quidus Temp (TL) to Peak	3 °C / second max.		
T <sub>S</sub> (max) to T <sub>L</sub>	Ramp-up Rate	3 °C / second max.		
5.4	Temperature (T <sub>L</sub> ) (Liquidus)	217 °C		
Reflow	Time (min to max) (t <sub>L</sub> )	60 ~ 150 seconds		
Peak Tempe	Peak Temperature (T <sub>P</sub> )			
Time of within 5 °C of Actu	Time of within 5 °C of Actual Peak Temperature ( $t_P$ )			
Ramp-do	6 °C / second max.			
Time from 25 °C to	8 Minutes max.			
Do Not	260 °C			

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## Flow/Wave Soldering (Solder Dipping)

Peak Temperature	260 °C+0 /- 5 °C	
Dipping Time	10 seconds	
Soldering Number	1 time	

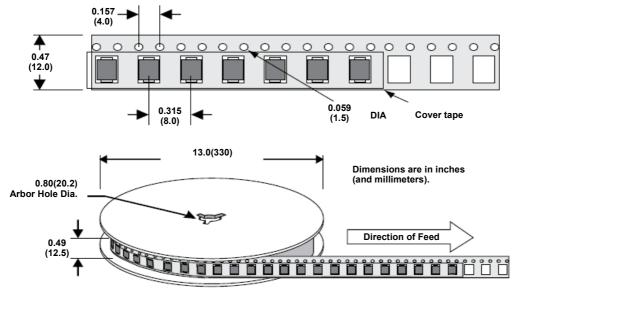
SETsafe SET fuse

**SACB Series** 

# SETsafe SET fuse SACB Series

# **Packaging Information**

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Part Number	Package	QTY (Reel)	Packaging Option	Packaging Specification
SACBXX	DO-214AA	3000 PCS	Tape & Reel - 12 mm tape/13" reel	EIA RS-481







#### Usage

- 1.TVS must be operated in the specified ambient temp.
- 2.Do not clean the TVS with strong polar solvent such as ketone, esters, benzene and halogenated hydrocarbon, to avoid damaging the encapsulating layer.
- 3.Please do not apply severe vibration, shock or pressure to TVS, to avoid element cracking.

## Replacement

1.If TVS is visually damaged, please replace it.2.TVS is a non-repairable product. For safety sake, please use equivalent TVS for replacement.

## Storage

- 1.Storage Temp. Range: (-55 to 150) °C.
- 2.Do not store the TVS at the high temp., high humidity or corrosive gas environment, to avoid influencing the solder- ability of the lead wires. The product shall be used up within 1 year after receiving the goods.

## **Environmental Conditions**

- 1.TVS should not be exposed to the open air, nor direct sunshine.
- 2.TVS should avoid rain, water vapor or other condition of high temp. and high humidity.
- 3.TVS should avoid sand dust, salt mist, or other harmful gases.

## Max. Typical Capacitance of TVS

The typical capacitance of TVS is listed in the specifications. Designers may refer to it when designing TVS in High frequency circuit.

## **Installation Mechanical Stress**

1.Do not knock TVS when installing, to avoid mechanical damage.

2.Please do not apply severe vibration, shock or pressure to TVS, to avoid surface resin or element cracking.